HALOGEN FREE



Vishay Siliconix

## N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
40	0.0075 at V <sub>GS</sub> = 10 V	20.5	21 nC			
40	0.009 at V <sub>GS</sub> = 4.5 V	18.7	21110			

		SO-8		
S	1		8	D
S	2		7	D
S	3		6	D
G	4		5	D
	ļ	Top View	ı	

Ordering Information: Si4124DY-T1-E3 (Lead (Pb)-free)

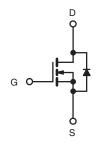
Si4124DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested

### **APPLICATIONS**

- · Synchronous Rectification
- DC/DC



N-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	40		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V
	T <sub>C</sub> = 25 °C		20.5	
Continuous Drain Current /T 150 °C)	T <sub>C</sub> = 70 °C		16.4	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	13.6 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		10.9 <sup>a, b</sup>	A
Pulsed Drain Current		I <sub>DM</sub>	50	
Avalanche Current  Avalanche Energy  L = 0.1 mH		I <sub>AS</sub>	33	
		E <sub>AS</sub>	54	mJ
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		4.7	A
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	2.1 <sup>a, b</sup>	A
	T <sub>C</sub> = 25 °C		5.7	
Maximum Dawar Dissination	T <sub>C</sub> = 70 °C	D	3.6	W
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	VV
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>	
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	39	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	18	22	0/ **		

### Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on  $T_C$  = 25 °C.

## **Si4124DY**

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<b>SPECIFICATIONS</b> $T_J = 25$ °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V, } I_D = 250  \mu\text{A}$	40			٧	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		46		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	10 = 200 μΑ		- 6.7		IIIV/ C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	1		3	٧	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zawa Cata Waltana Duain Courant	,	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			5	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Due to Course On Otata Daviators of	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 14 A		0.0062	0.0075		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12 A		0.0073	0.009	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 16 A		55		S	
Dynamic <sup>b</sup>	•			· ·			
Input Capacitance	C <sub>iss</sub>			3540			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		335		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			142			
		V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 16 A		51	77		
Total Gate Charge	Q <sub>g</sub> —			21	32	_	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 16 \text{ A}$		10.7		nC	
Gate-Drain Charge	Q <sub>gd</sub>			3.0			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.75	1.5	Ω	
Turn-on Delay Time	t <sub>d(on)</sub>			30	45		
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_{L} = 2 \Omega$		14	21		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		38	60	1	
Fall Time	t <sub>f</sub>			11	17		
Turn-on Delay Time	t <sub>d(on)</sub>			14	21	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_{L} = 2 \Omega$		10	15	_	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		32	50		
Fall Time	t <sub>f</sub>			8	15		
<b>Drain-Source Body Diode Characteristi</b>	cs			L			
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			32		
Pulse Diode Forward Current	I <sub>SM</sub>				50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			25	50	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1		19	38	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		13			
Reverse Recovery Rise Time	t <sub>b</sub>	1		12		ns	

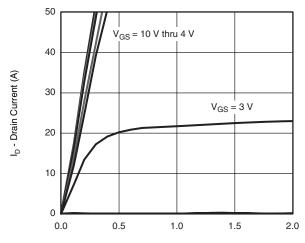
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



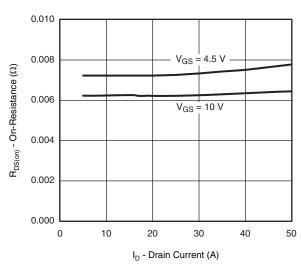
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

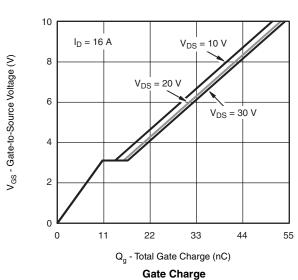


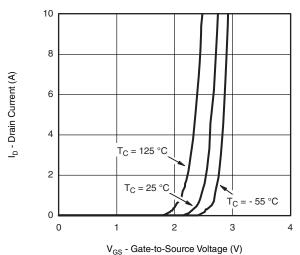
V<sub>DS</sub> - Drain-to-Source Voltage (V)

### **Output Characteristics**

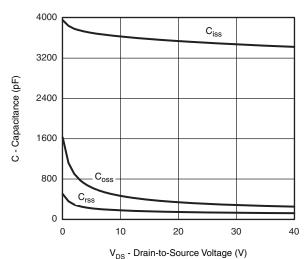


On-Resistance vs. Drain Current and Gate Voltage

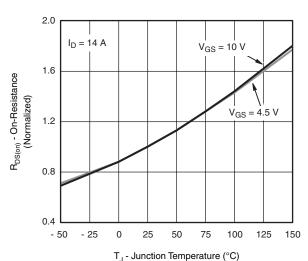




### **Transfer Characteristics**



### Capacitance



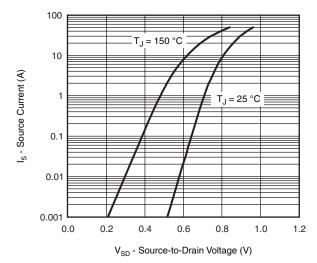
On-Resistance vs. Junction Temperature

## **Si4124DY**

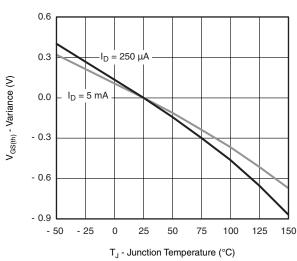
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



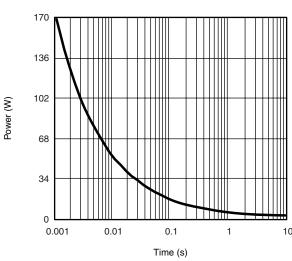
### Source-Drain Diode Forward Voltage



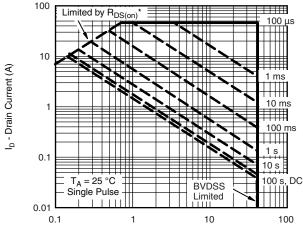
**Threshold Voltage** 

V<sub>GS</sub> - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



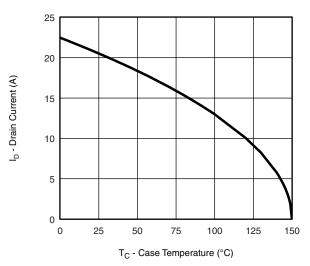
 $\rm V_{DS}$  - Drain-to-Source Voltage (V)  $^*$   $\rm V_{DS}$  > minimum  $\rm V_{GS}$  at which  $\rm R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

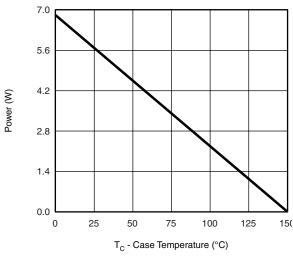


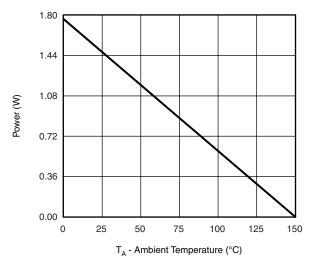
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



### Current Derating\*, Junction-to-Foot





Power Derating, Junction-to-Foot

Power Derating, Junction-to-Ambient

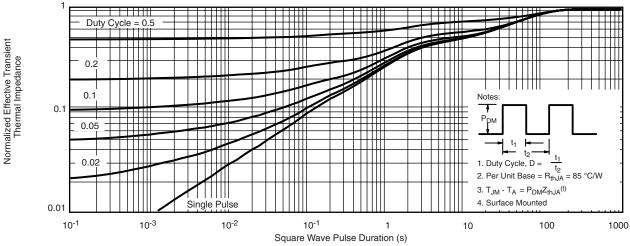
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

## **Si4124DY**

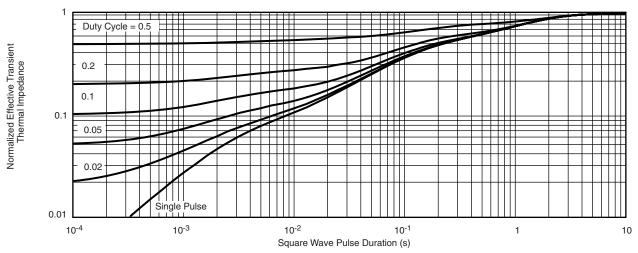
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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